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ISSUE CLASSIFICATION	
Class	Subclass

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PATENT NUMBER

U.S. **UTILITY** Patent Application

<p>KC O.I.P.E.</p> <p>SCANNED 5/2/2011 Q.A. AA</p>	<p>PATENT DATE</p>
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APPLICATION NO. 09/878265	CONT/PRIOR F	CLASS 029	SUBCLASS 846	ART UNIT 3729	EXAMINER J. M. B.
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APPLICANTS

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TITLE

Method of machining glass substrate and method of fabricating high-frequency circuit

PTQ-2040
12/99

ISSUING CLASSIFICATION												
ORIGINAL				CROSS REFERENCE(S)								
CLASS		SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)							
INTERNATIONAL CLASSIFICATION												

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<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
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	_____ (Date)		ISSUE FEE	
_____ (Primary Examiner)				
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Date)		ISSUE BATCH NUMBER	
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner)			
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